

**AH41** 

## **Pin Configuration**

Z3 Package (TO-92S-3)

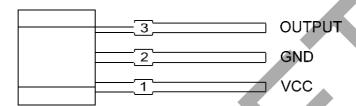


Figure 2. Pin Configuration of AH41 (Front View)

# **Pin Description**

Pin Number	Pin Name	Function		
1	VCC	Power supply pin		
2	GND	Ground pin		
3	OUTPUT	Output pin. It is low during the N magnetic field		



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### **Functional Block Diagram**

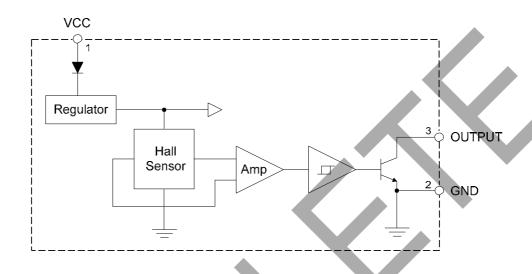
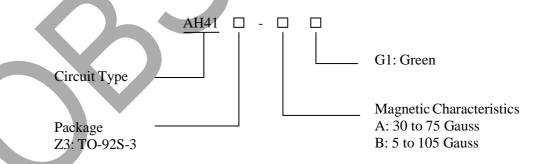


Figure 3. Functional Block Diagram of AH41

## **Ordering Information**



Package	Temperature Range	Part Number	Marking ID	Packing Type	
TO-92S-3	-40 to 150°C	AH41Z3-AG1	AH41	Bulk	
		AH41Z3-BG1	AH41	Bulk	

BCD Semiconductor's Pb-free products, as designated with "G1" suffix in the part number, are RoHS compliant and green.



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#### **Absolute Maximum Ratings (Note 1)**

Parameter	Symbol	Value	Unit
Supply Voltage	V <sub>CC</sub>	-24 to 28	V
Output OFF Voltage	$V_{CE}$	30	V
Output Sink Current (Continuous Current)	I <sub>OUT</sub>	50	mA
Power Dissipation (T <sub>A</sub> =25°C)	$P_D$	400	mW
Storage Temperature	$T_{STG}$	-65 to 150	°C
Junction Temperature	$T_{\rm J}$	150	°C
ESD (Machine Model)		300	V
ESD (Human Body Model)		2000	V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

# **Recommended Operating Conditions (T<sub>A</sub>=25°C)**

Parameter	Symbol	Min	Max	Unit
Supply Voltage	$V_{CC}$	4	24	V
Operating Temperature	$T_{OP}$	-40	150	°C



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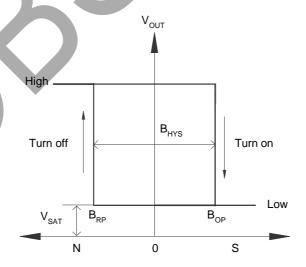
### **Electrical Characteristics**

 $V_{CC}\!=\!12V, T_A\!=\!\!25^{\circ}\!C,$  unless otherwise specified.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	$V_{CC}$		4		24	V
Supply Current	$I_{CC}$	V <sub>CC</sub> =4V to 24V		6	9	mA
Output Leakage Current	$I_{OL}$	V <sub>CE</sub> =14V		0.1	10	μA
Output Saturation Voltage	$V_{SAT}$	I <sub>OUT</sub> =20mA		110	300	mV
Rise Time	tr	$R_L=820\Omega$ $C_L=20pF$		200		ns
Fall Time	tf	$R_L=820\Omega$ $C_L=20pF$		100		ns

# Magnetic Characteristics (T<sub>A</sub>=25°C)

Parameter	Symbol	Grade	Min	Тур	Max	Unit	
Operating Point	B <sub>OP</sub>	A	30	•	75	Gauss	
		В	5		105	Gauss	
Releasing Point	$B_{RP}$	A	-75		-30	Gauss	
		В	-105		-5	Gauss	
Hysteresis	B <sub>HYS</sub>		80	110	140	Gauss	



Magnetic Flux Density (Gauss)



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### **Test Circuit**

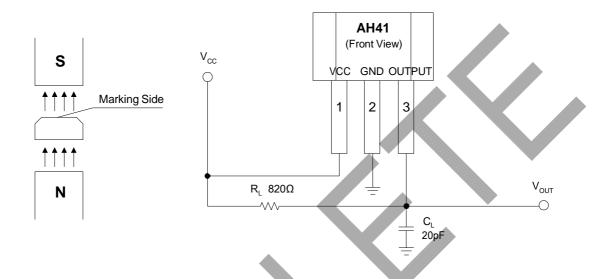
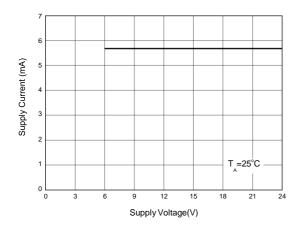


Figure 4. Basic Test Circuit of AH41



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## **Typical Performance Characteristics**



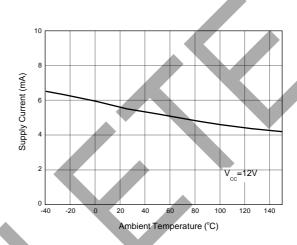
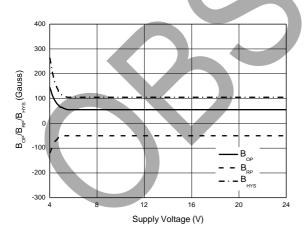


Figure 5. Supply Current vs. Supply Voltage

Figure 6. Supply Current vs. Ambient Temperature



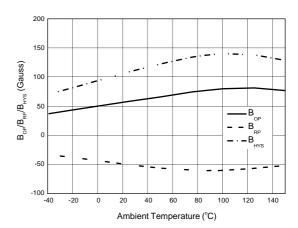


Figure 7. Bop/BRP/BHYS vs. Supply Voltage

Figure 8. Bop/BRP/BHYS vs. Ambient Temperature



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## **Typical Performance Characteristics (Continued)**

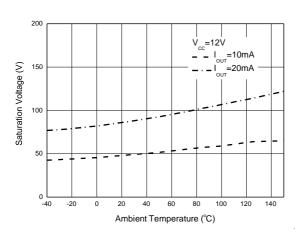


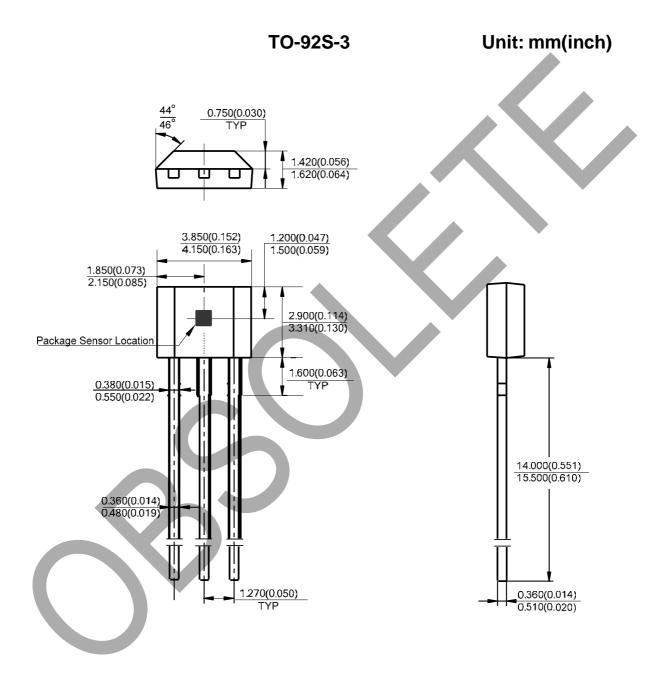
Figure 9. Saturation Voltage vs. Ambient Temperature





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#### **Mechanical Dimensions**







#### **BCD Semiconductor Manufacturing Limited**

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#### MAIN SITE

- Headquarters BCD Semiconductor Manufacturing Limited

No. 1600, Zi Xing Road, Shanghai ZiZhu Science-based Industrial Park, 200241, China Tel: +86-21-24162266, Fax: +86-21-24162277

#### REGIONAL SALES OFFICE

Shenzhen Office

Shanghai SIM-BCD Semiconductor Manufacturing Co., Ltd., Shenzhen Office Unit A Room 1203, Skyworth Bldg., Gaoxin Ave.1.S., Nanshan District, Shenzhen, China Tel: +86-755-8826 7951

#### - Wafer Fab

Shanghai SIM-BCD Semiconductor Manufacturing Co., Ltd.

800 Yi Shan Road, Shanghai 200233, China Tel: +86-21-6485 1491, Fax: +86-21-5450 0008

#### Taiwan Office

BCD Semiconductor (Taiwan) Company Limited 4F, 298-1, Rui Guang Road, Nei-Hu District, Taipei, Taiwan

Tel: +886-2-2656 2808 Fax: +886-2-2656 2806

#### USA Office

BCD Semiconductor Corp. 30920 Huntwood Ave. Hayward, CA 94544, USA Tel: +1-510-324-2988

Fax: +1-510-324-2788